



AD5391BCPZ-3 Information



For Reference Only

Part Number AD5391BCPZ-3

Manufacturer Analog Devices Inc.

Category Integrated Circuits (ICs)

Data Acquisition - Digital to Analog Converters

(DAC)

Description IC DAC 12BIT I2C 16CH 3V 64LFCSP

Package 64-VFQFN Exposed Pad, CSP

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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AD5391BCPZ-3 Specifications

Manufacturer Part Number Manufacturer Analog Devices Inc. Integrated Circuits (ICs) Data Acquisition - Digital to Analog Converters (DAC) Package 64-VFQFN Exposed Pad, CSP Series - Number of Bits 12 Number of D/A Converters 16 Settling Time 8µs Output Type Voltage - Buffered Differential Output No Data Interface I2C, SPI, DSP Reference Type External, Internal Voltage - Supply, Analog 2.7 V ~ 3.6 V Voltage - Supply, Digital INL/DNL (LSB) Architecture Operating Temperature Package / Case 64-VFQFN Exposed Pad, CSP		
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Reference Type External, Internal $ \begin{tabular}{ll} Voltage - Supply, Analog & 2.7 \ V \sim 3.6 \ V \\ Voltage - Supply, Digital & 2.7 \ V \sim 5.5 \ V \\ INL/DNL (LSB) & \pm 1 \ (Max), \pm 1 \ (Max) \\ Architecture & String DAC \\ Operating Temperature & -40^{\circ}C \sim 85^{\circ}C \\ Package / Case & 64-VFQFN Exposed Pad, CSP \\ \end{tabular} $	Differential Output	No
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Package / Case 64-VFQFN Exposed Pad, CSP	Architecture	String DAC
	Operating Temperature	-40°C ~ 85°C
CALECON VO (0-0)	Package / Case	64-VFQFN Exposed Pad, CSP
Supplier Device Package 64-LPCSP-VQ (9x9)	Supplier Device Package	64-LFCSP-VQ (9x9)
Mounting Type -	Mounting Type	-
Report errors		Report errors?

AD5391BCPZ-3 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

AD5391BCPZ-3 Payment Methods



















AD5391BCPZ-3 Shipping Methods













If you have any question about AD5391BCPZ-3, please do not hesitate to contact us!

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